



Micro/Nano Manufacturing

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Message from the Guest Editors

Dear Colleagues,

Micro manufacturing is dealing with the fabrication of structures in the order of 0.1 to 1000 μm . The scope of nano manufacturing extends the size range of manufactured features to even smaller length scales below 100 nm. A sharp borderline between micro and nano manufacturing can hardly be drawn, such that both domains are treated as complementary within a closely interconnected scientific community. Application fields include, but are not restricted to, metrology, industrial technology, automotive technology, medical technology, and life sciences. This Special Issue is dedicated to recent advances in research and development within the field of micro and nano manufacturing. Therefore, papers are welcome that report recent findings and advances in manufacturing technologies for producing products with micro and nano scale features and structures. Furthermore, papers that report applications underpinned by such advances in micro and nano manufacturing technologies are also welcomed.

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Guest Editors





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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